

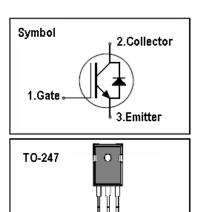
IGBT

Features

- $\blacksquare \quad 1200V, 20A, V_{CE(sat)(typ.)} = 2.1V @V_{GE} = 15V, \quad 20A \\$
- High speed switching
- Higher system efficiency
- Soft current turn-off waveforms
- Square RBSOA using NPT technology

General Description

KEDA NPT IGBTs offer lower losses and higher energy efficiency for application such as IH (induction heating),UPS, general inverter and other soft switching applications.



GCE

Absolute Maximum Ratings

Symbol	Parameter	Value	Units	
V _{CES}	Collector-Emitter Voltage 1200		V	
V_{GES}	Gate-Emitter Voltage ± 30		V	
	Continuous Collector Current (T _C =25 °C)	40	А	
IC	Continuous Collector Current (T _c =100°C)		А	
I _{CM}	I _{CM} Pulsed Collector Current (Note 1) 190		Α	
I _F	Diode Continuous Forward Current (T _C =100 °C)	15	Α	
I _{FM}	Diode Maximum Forward Current (Note 1)	lote 1) 190 A		
t _{sc}	t _{sc} Short Circuit Withstand Time 10		us	
D	Maximum Power Dissipation (T _C =25 °C)	192	W	
P_{D}	Maximum Power Dissipation (T _C =100°C)		W	
TJ	Operating Junction Temperature Range -55 to +150 °C		°C	
T _{STG}	Storage Temperature Range -55 to +150		°C	

Thermal Characteristics

Symbol	Parameter	Max.	Units
R _{th j-c}	Thermal Resistance, Junction to case for IGBT 0.45		
R _{th j-c}	R _{th j-c} Thermal Resistance, Junction to case for Diode		°C/W
R _{th j-a}	R _{th j-a} Thermal Resistance, Junction to Ambient		°C/W



$\underline{\textbf{Electrical Characteristics}} \; (\textbf{T}_{\texttt{C}} = 25 \text{°C unless otherwise noted})$

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
BV _{CES}	Collector-Emitter Breakdown Voltage	V _{GE} = 0V, I _C = 250uA	1200	-	-	V
I _{CES}	Collector-Emitter Leakage Current	V _{CE} = 1200V, V _{GE} = 0V	-	-	250	uA
ı	Gate Leakage Current, Forward	V_{GE} =30V, V_{CE} = 0V	1	-	100	nA
GES	Gate Leakage Current, Reverse	V_{GE} = -30V, V_{CE} = 0V	-	-	-100	nA
$V_{GE(th)}$	Gate Threshold Voltage	$V_{GE} = V_{CE}$, $I_{C} = 250uA$	4.5	-	5.5	V
V _{CE(sat)}	Collector-Emitter Saturation Voltage	$V_{GE} = 15V, I_{C} = 20A$	-	2.1	2.3	V
Qg	Total Gate Charge	V _{CC} =960V	-	120	140	nC
Q _{ge}	Gate-Emitter Charge	V _{GE} =15V	-	30	50	nC
Q _{gc}	Gate-Collector Charge	I _C =20A	-	60	80	nC
t _{d(on)}	Turn-on Delay Time		-	40	-	ns
t _r	Turn-on Rise Time	V _{CC} =600V	-	50	-	ns
t _{d(off)}	Turn-off Delay Time	V _{GE} =15V	-	450	-	ns
t f	Turn-off Fall Time	I _C =20A R _G =28Ω	-	100	-	ns
Eon	Turn-on Switching Loss	Inductive Load	-	1.5	-	mJ
Eoff	Turn-off Switching Loss	T _C =25 °C	-	1.2	-	mJ
Ets	Total Switching Loss		-	2.7	-	mJ
Cies	Input Capacitance	V _{CE} =25V V _{GE} =0V	-	540	-	pF
C _{oes}	Output Capacitance		-	135	-	pF
C _{res}	Reverse Transfer Capacitance	f = 100kHz	•	77	-	pF
R _{Gint}	Integrated gate resistor		1.8	1.9	2.0	Ω

Electrical Characteristics of Diode (T_C=25°C unless otherwise noted)

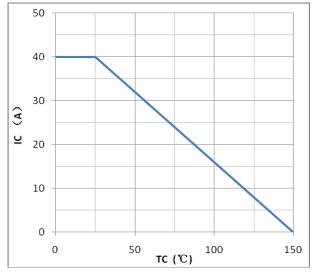
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
V _F	Diode Forward Voltage	I _F =15A	1.8	-	2.4	V
t _{rr}	Diode Reverse Recovery Time	V _{CE} = 600V	-	110		ns
Irr	Diode peak Reverse Recovery Current	I _F = 15A	-	16		Α
Q _{r r}	Diode Reverse Recovery Charge	$dI_F/dt = 500A/us$	-	1060		nC

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature



Typical Performance Characteristics



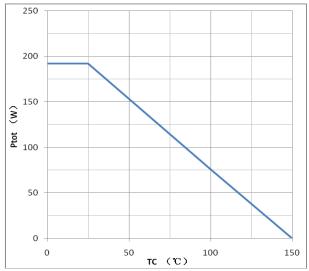
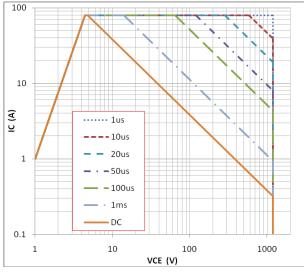


Figure1:maximum DC collector current VS. case temprature

Figure2:power dissipation VS. case temprature



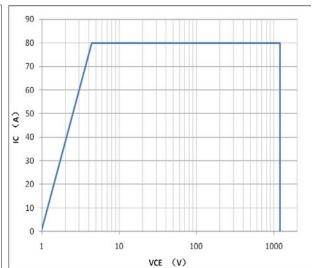
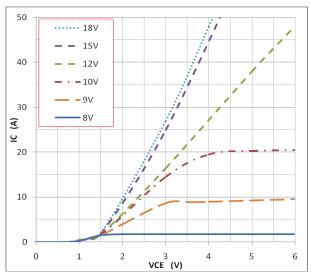
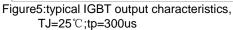


Figure3:forward SOA,TC=25°C,TJ≤150°C

Figure4:reverse bias SOA,TJ=150 $^{\circ}$ C,VGE=15V





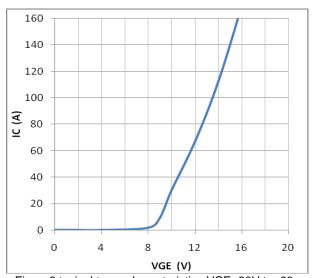


Figure6:typical trans characteristics, VCE=20V,tp=20us

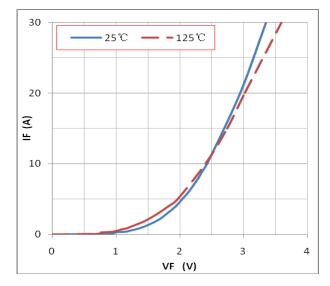


Figure7:typical diode forward characteristic,tp=300us

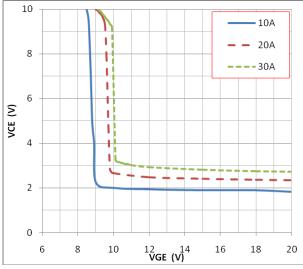
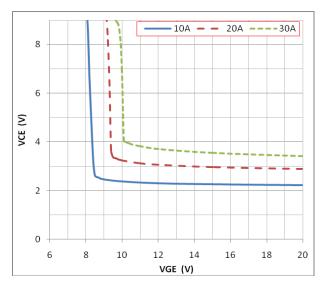


Figure8:typical VCE VS. VGE,TJ=25°C





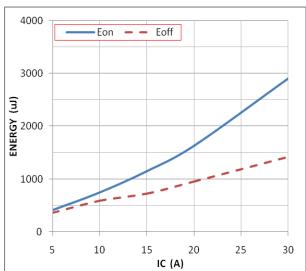
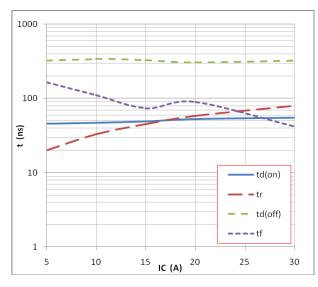


Figure9: typical VCE VS. VGE,TJ=125°C

Figure 10: typical energy loss VS. IC, TC=25°C,L=500uH,

 $VCE=600V,VGE=15V,Rg=28\Omega$



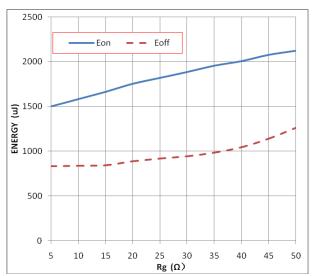
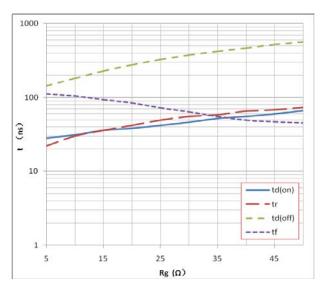


Figure11: typical switching time VS. IC, TC=25°C,

Figure 12: typical energy loss VS. Rg,TC=25 $^{\circ}$ C,

L=500uH, VCE=600V,VGE=15V,Rg= 28Ω

L=500uH,VCE=600V,VGE=15V,IC=20A



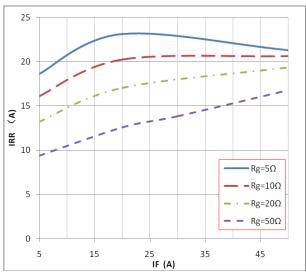
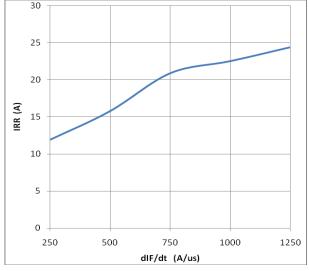


Figure13: typical switching time VS. Rg,TC=25°C,

L=500uH,VCE=600V,VGE=15V,IC=20A

Figure14: typical diode IRR VS. IF, TC=25°C

VCC=600V,VGE=15V



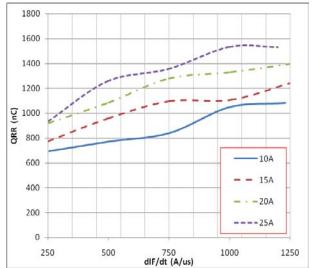


Figure15:typical diode IRR VS. dIF/dt VCC=600V,VGE=15V,IF=20A

Figure16:typical diode QRR VS. dIF/dt VCC=600V,VGE=15V

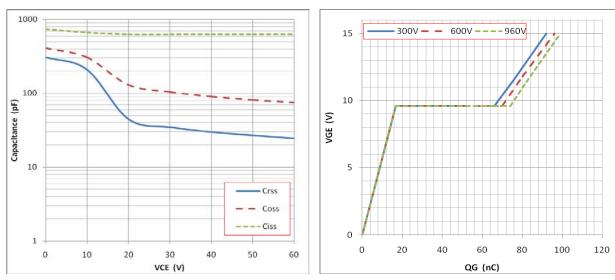


Figure17:typical capacitance VS. VCE,VGE=0V,f=100kHz

Figure 18: typical gate charge VS. VGE,IC=20A

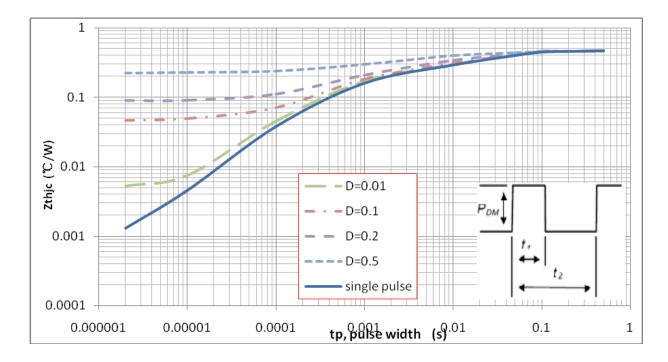
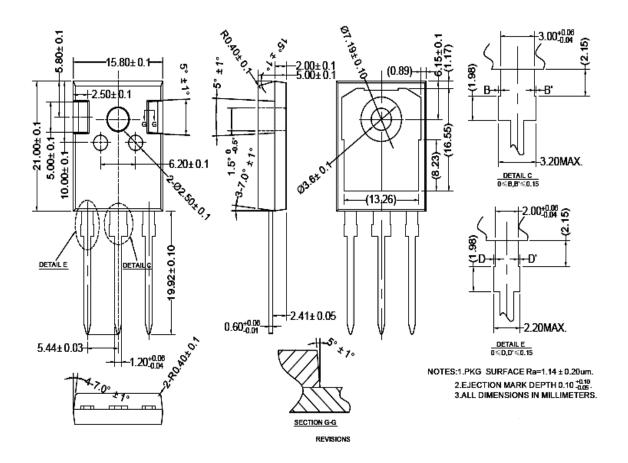


Figure19:normalized transient trermal impedance,junction-to-case

Note1.Duty factor D=t1/t2; Note2:peak TJ=PDM×Zthjc+TC



TO247 PACKAGE OUTLINE



公差标注	公差值	表面粗糙度
0	±0.2	Ra3.2~6.3
0.0	±0.1	Ra1.6~3.2
0.00	±0.01	Ra0.8~1.6
0.000	±0.005	Ra0.4~0.8
0.0000	±0.002	Ra0.2~0.4

0≤D,D'≤0.15

NOTES:1.PKG_SURFACE Ra=1.14 ± 0.20 um. 2.EJECTION MARK DEPTH 0.10 +0.10 3.ALL DIMENSIONS IN MILLIMETERS.





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